## NSN 5962-01-248-8654

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## **Body Length:** 1.060 inches **Body Width:** Between 0.220 inches and 0.310 inches **Body Height:** 0.185 inches **Maximum Power Dissipation Rating:** 2.0 watts **Operating Tempurature Range:** -55.0/+125.0 degrees celsius Storage Tempurature Range: -65.0/+150.0 degrees celsius **Features Provided:** Hermetically sealed and burn in and programmable and bipolar and monolithic **Inclosure Material:** Ceramic Inclosure Configuration: Dual-in-line **Output Logic Form:** Bipolar metal-oxide semiconductor **Input Circuit Pattern:** 12 input **Case Outline Source And Designator:** D-8 mil-m-38510 **Current Rating Per Characteristic:** 100.00 milliamperes output sink **Terminal Surface Treatment:** Solder Voltage Rating And Type Per Characteristic: 5.0 volts power source **Time Rating Per Chacteristic:** 45.00 nanoseconds propagation delay time, low to high level output and 45.00 nanoseconds propagation delay time, high to low level output Memory Device Type: Pal **Test Data Document:** 81349-mil-m-38510 specification (includes engineering type bulletins, brochures, etc., that reflect specification type data in specification format; excludes commercial catalogs, industry directories, and similar trade publications, reflecting general type data on certain environmental and performance requirements and test conditions that are shown as "typical", "average", "", etc.). **Terminal Type And Quantity:**

20 printed circuit

Specification Data:

81349-mil-m-38510/503 government specification

Shelf Life:

NI/o

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Unit Of Measure:

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Demilitarization:

No

Fiig:

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